| Discipline: ELECTRICAL ENGG. | Semester: 3th Sen                                | Name of the Teaching Faculty: Zahid Akhtar  |
|------------------------------|--|---|
| Subject : EEM                | No. of Days /<br>per week class<br>allotted : 04 | From date : 01.08.2023 To Date : 30.11.2023<br>No. of Weesks : 15   |
| Week                         | Class Day  | Topics  |
| 01-08-2023 TO 03-08-2023     | 1st  | Chapter 1 ( CONDUCTING MATERIAL )  1. 1 Introduction  |
|                              | 2nd  | 1. 2 Resistivity, factors affecting resistivity   |
|                              | 3rd  | 1. 3 Classification of conducting materials into  |
| 07-08-2023 TO 10-08-2023     | 1st  | low-resistivity and high resistivity materials  |
|                              | 2nd  | 1. 4 Low Resistivity Materials  |
|                              | 3rd  | Application of copper   |
|                              | 4th  | Application of silver and gold  |
|                              | 100  | , pp. marian and a second a second and a second a second and a second |
| 14-08-2023 TO 17-08-2023     | 1st  | Application of Iluminium and steel  |
|                              | 2nd  | 1. 5 Stranded conductors  |
|                              | 3rd  | 1. 6 Bundled conductors   |
| 21-08-2023 TO 24-08-2023     | 1st  | 1. 7 Low resistivity copper alloys  |
|                              | 2nd  | 1. 8 High Resistivity Materials and their Applications (Tungsten, Carbon, Platinum, Mercury)  |
|                              | 3rd  | 1. 9 Superconductivity  |
|                              | 4th  | 1. 10 Superconducting materials   |
| 28-08-2023 TO 31-08-2023     | 1st  | 1. 11 Application of superconductor materials   |
|                              | 2nd  | 1. 11 Application of superconductor materials   |
|                              | 3rd  | SEMICONDUCTING MATERIAL (CHAPTER 2) 2.1 Introduction  |
|                              | 1st  | 2. 2 Semiconductors   |
| Elita de la Salada de la F   | 2nd  | 2. 4 Excitation of Atoms  |
| 04-09-2023 TO 07-09-2023     |  | 2. 5 Insulators, Semiconductors and Conductors , 2.6  |
|                              | 3rd<br>  | Semiconductor Material  |
|                              | 4.4  | 2. 7 Covalent Bonds 2.8   |
|                              | 1st  | Intrinsiv Semiconductor   |
|                              | 2nd  | 2. 8 Intrinsic Semiconductors   |
|                              |  | 2. 9 Extrinsic Semiconductors   |
| 11-09-2023 TO 14-09-2023     | 2-4  | 2. 10 N-Type Materials  |
|                              | 3rd  | 2. 11 P-Type Materials  |
|                              |  | 2. 12 Minority and Majority Carriers  |
|                              | 4th  | 2. 13 Semi-Conductor Materials  |
|                              |  | 2.14 Application of rectifier, photo conducting cell, photo voltaic   |
| 18-09-2023 TO 21-09-2023     | 1st  | cell , varisters  |
|                              | 2nd  | hall effect generator, solar power.   |
| 25-09-2023 TO 28-09-2023     | 1st  | INSULATING MATERAL(CHAPTER 3) 3.1 Introduction,general property of insulating material  |
|                              | 2nd  | electrical, visual, mechanical, thermal, chemical property, ageing  |
|                              | 3rd  | 3.3 Insulating Materials – Classification, properties,  |
|                              | 4th  | applications 3.3.1 Introduction   |
|                              |  |   |
|                              |  |   |
|                              | 1st  | 3.3.2 Classification of insulating materials on the basis physical  |
|                              |  | structure   |
| 03-10-2023 TO 05-10-2023     | 1st<br>2nd<br>3rd                                |   |

| 09-10-2023 TO 12-10-2023 | 1st        | 3.4.1 Introduction.   |
|--------------------------|------------|---|
|                          | 2nd        | 3.4.2 Commonly used insulating gases  |
|                          | 2.4        | DIELECTRIC MATERIAL(CHAPTER 4)  |
|                          | 3rd        | 4.1 Introduction  |
|                          | 4th        | 4.2 Dielectric Constant of Permittivity   |
| 16-10-2023 TO 19-10-2023 | 1st        | 4.3 Polarization  |
|                          | 2nd        | 4.4 Dielectric Loss   |
|                          | 2110       | 4.4 Dielectric Loss   |
|                          | 3rd        | 4.5 Electric Conductivity of Dielectrics and their Break Down                     |
| 19594                    | 4th        | 4.6 Properties of Dielectrics.  |
|                          | 1st        | 4.7 Applications (D) I am   |
|                          | 2nd        | 4.7 Applications of Dielectrics   |
| Marie Person             | 2110       | 4.7 Applications of Dielectrics   |
| 30-10-2023 TO 02-11-2023 | 3rd        | MAGNETIC MATERIAL (CHAPTER 5) 5.1   |
|                          | 4th        | Introduction  |
|                          |            | 5.2 Classification  |
|                          |            | 5.2.1 Diamagnetism  |
|                          |            |   |
|                          | 1st        | 5.2.2 Para magnetism  |
| Market State Control     |            | 5.2.3 Ferromagnetism  |
| 06-11-2023 TO 09-11-2023 | 2nd        | 5.3 magnetization curve   |
|                          | 3rd        | 5.4 Hysteresis  |
|                          | 446        | 5.5 Eddy current  |
|                          | 4th        | 5.6 Curie Point ,5.7 Magneto- striction   |
|                          | 1st        | 5.8 Soft and Hard magnetic Materials  |
|                          |            | 5.8.1 Soft magnetic materials   |
| 13-11-2023 TO 16-11-2023 | 2nd        | 5.8.2 Hard magnetic materials   |
|                          | 2-4        | MATERIAL FOR SPECIAL PURPOSES(CHAPTER 6) 6.1                                      |
|                          | 3rd        | Introduction  |
|                          | 4th        | 6.2 Structural Materials  |
|                          | 1c+        | C 2 D   |
|                          | 1st<br>2nd | 6.3 Protective Materials  |
|                          | 2110       | 6.3.1 Lead  |
| 20-11-2023 TO 23-11-2023 | 3rd        | <ul><li>6.3.2 Steel tapes, wires and strips</li><li>6.4 Other Materials</li></ul> |
|                          | 4th        | 6.4.1 Thermocouple materials  |
|                          | 1st        | C 4 2 P:  |
|                          | 2nd        | 6.4.2 Simetals  |
| 28-11-2023 TO 30-11-2023 | Znd        | 6.4.3 Soldering Materials   |
|                          | 3rd        | 6.4.4 Fuse and Fuse materials. 6.4.5  |
|                          |            | Dehydrating material  |

Signature of Faculty

Signature of HOD Electrical Engineering Department